

REVIEW

Potential of Eco-Friendly Gases to Substitute SF₆ for Electrical HV Applications as Insulating Medium: A Review

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Cite this article as: T. Ahmad Raza, M. Kamran, M. Umar Khallidoon & M. Niaz Akhtar. Potential of eco-friendly gases to substitute SF₆ for electrical HV applications as insulating medium: A review. *Turk J Electr Power Energy Syst*, 2022; 2(1): 94-102.

ABSTRACT

Compressed gas is an essential ingredient for high-voltage (HV) applications, especially as an insulating medium. Sulfur hexafluoride (SF₆) gas due to its excellent insulating features is being preferred for decades and is widely utilized in applications such as gas-insulated switchgear, gas-insulated bus bars, circuit-breakers (CB), etc. But its global warming potential has been reported at the utmost harmful level. Many environmental anomalies have been produced by greenhouse gases, the reason why this problem has got extraordinary consideration, and there is an emergent need to introduce some eco-friendly substitute for SF₆. The research was started almost 4 decades ago to find a replacement for SF₆; however, progress in recent years is much better than earlier. Now, many alternatives have been searched out, and tests are being performed to find the best of them. In this study, the progress of some eco-friendly gases such as natural gases, trifluoriodomethane, dichlorodifluoromethane, tetrafluoroethane, perfluoroketones, and heptafluoroisobutyronitrile has been summarized, keeping in view the basic physical properties and electrical insulating features. Decomposed by-products and boiling point were also discussed in detail, and the conclusion deduced that perfluoroketone and heptafluoroisobutyronitrile, with mixture of natural gases, show much better potential to replace SF₆ in many of the HV applications; later one has a bit upper edge.

Index Terms—Boiling point, circuit breakers, decomposed by-products, dielectric strength, gas-insulated switchgear, global warming potential

I. INTRODUCTION

There is a certain reason for increased usage of sulfur hexafluoride (SF₆) for years because of some limitations of air and oil such as more space required for the technical development of higher voltage range [1]. Air is a mixture of low electronegative gases and so its breakdown strength is very low, and to obtain a higher voltage range, it requires a lot of space. The maintenance of oil is poor, and also, it is a fire hazard. So, SF₆ gas is being considered as the best insulating medium because it requires less maintenance and is very safe to operate [2].

The main feature of SF₆ is its dielectric breakdown strength that is almost three times more than that of air, which is a strong electronegative gas. Space between electrodes is decreased due to its higher breakdown strength, resulting in smaller equipment [1, 2]. Another feature of SF₆ is its arc-quenching capability with

excellent dielectric recovery strength, as its molecules reform very quickly after an arc or electrical discharge [3]. It also exhibits good heat transfer and thermal interrupting properties. Some other important properties of SF₆ were as follows: it is a non-toxic [4], non-flammable, colorless, and odorless gas and is chemically and thermally very stable.

But, the two significant issues related to SF₆ utilization in electrical equipment are its very high global warming potential and its bit higher liquefaction temperature.

First, global warming potential of SF₆ is more than 23 000, which can sustain over 100 years, and Kyoto Protocol identified SF₆ as one of the six major greenhouse gases [5, 6], in which the harmful level indicates that SF₆ badly affects the environment. SF₆ was labeled as regulated gas at third Framework Convention on Climate Change [7],

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Received: August 1, 2021
Accepted: October 26, 2021
Available online: November 18, 2021

apart from this, Paris (France) Agreement 2016 also demands zero emission of greenhouse gases in later half of the century [8]. Its liquefaction temperature is also bit higher, relative to some natural gases, which is -64°C at 0.1 MPa [9]. SF₆ also has some other adverse properties like corrosion and toxic by-products formation resulting from electrical discharges. At the time, China is the leading country in emission of SF₆, and 70% of it comes from electrical equipment, followed by semiconductor manufacturing, magnesium production, and SF₆ preparation, each contributing around 10% of the remaining [10]. The leakage rate of SF₆ is very low, but debugging, recycling of SF₆, normal leakage and maintenance of SF₆-insulated switchgears, circuit-breaker (CB), etc. contribute to emission in atmosphere. More advanced detectors for leakage should be adopted to reduce SF₆ gas emission [11], and campaign should also be initiated to endorse recycling processes. But still, this will not be enough to eliminate greenhouse effect and toxic decomposed by-products. SF₆ gas has been utilized up to the range of 800 kV because there were no alternatives available with the same insulation and quenching properties, the main features of insulating medium. But now, there are many alternatives that show much potential for replacement. Some review articles have also been published in recent years in which some useful comparison between available options has been made. For example, an overview of green gas for the application of switchgear, in comparison with SF₆, was published [12]; however, the article did not consider other potential options. Similarly, some other articles [13, 14] have also reviewed the potential replacement but either covered very few options or missed some properties to discuss. So, in this article, efforts have been made to include every potential option of replacement with discussion on most concerned features.

II. ECO-FRIENDLY SUBSTITUTE GASES

Eco-friendly substitute gases of SF₆ must have safety and environmental needs that should be fulfilled, that is, they should be non-toxic and non-flammable, but the two major features of being eco-friendly which cannot be compromised are low global warming potential (GWP) and zero ozone depletion potential.

In addition, some other features needed for usage in electrical HV equipment are:

- i. excellent dielectric strength (high withstand and breakdown voltage level);
- ii. excellent arc-quenching capability with fast dielectric recovery;
- iii. low boiling point with a high cooling capacity;
- iv. high heat dissipation;
- v. should be chemically and thermally stable;
- vi. compatible with the material of circuit breaker, transmission line, switchgear, and design compactness.

Among natural gases, nitrogen (N₂) and carbon dioxide (CO₂) being easily available, non-toxic, non-combustive, and with stable physico-chemical properties made them the first choice of consideration as alternatives for SF₆, almost 4 decades ago. N₂, one of the most stable and inert gas, exhibits zero GWP [15], while GWP of CO₂ is taken as one, which makes both of them eco-friendly.

Another compound named trifluoroiodomethane having formula CF₃I is under consideration. It is an odorless and colorless gas with GWP only around 0.5 and lifetime around 2 days. Its ozone depletion potential is almost zero, which is another encouraging feature. CF₃I has some other useful potentials such as being used in semiconductor etching and foaming agents, etc. National Fire Protection Association authenticated CF₃I as a fire extinguishing agent [16] and as an optimal alternative for Halon.

(C_nF_{2n}O) is the generic formula for fluoroketones which have been used as fire extinguishers for the last one decade and so. C₆F-ketone has dielectric strength around 1.7 times of SF₆ showing an excellent insulating capability [17]. Its toxicity level is also low, and more importantly, it has GWP level of around 1 with an atmospheric lifetime of only a week. C₄-PFK and C₅-PFK are other compounds from the same family with lower molecular weight and lower boiling point, and they exhibit almost equivalent dielectric strength as C₆F-ketone [18].

Dichlorodifluoromethane (R₁₂) and tetrafluoroethane (R₁₃₄) have recently been introduced as alternatives to SF₆, exhibiting relevant features, such as lower GWP with less atmospheric lifetime and good self-recoverability [16, 19, 20].

Heptafluoroisobutyronitrile is a compound from fluoronitrile family with formula (C₄F₇N), which is commercially accessible with the name 3M™ Novec™ 4710 dielectric fluid. The fluid got attention because its GWP is almost 10 times lower than that of SF₆, which is around 2100, with dielectric strength almost twice that of SF₆ at atmospheric pressure [17]. It also has high thermal transfer capability, and its toxicity level is quite low.

A. Basic Physical Properties

Basic physical properties are important in a sense because these determine the arc-quenching capability and dielectric strength. Relations are very complex, but still, properties are helpful to assess the potential of insulating medium. Studies of basic physical properties with comparison have been carried out that primarily include thermal and electrical conductivities. Temperature dependence of electrical conductivity is almost similar for most of the alternative gases [21], as shown in Fig. 1.

The electrical conductivity of most gases start increasing from 7000 K, but SF₆ and CF₃I start a bit earlier around 5000 K. It is due to the presence of sulfur and iodine, respectively, which have lower ionization energies. Increase is almost steady till 24 000 K. Unlike electrical conductivity, thermal conductivity behavior is much different and depends strongly on the nature of the gas. Typical characteristics are shown in Fig. 2, which clearly reveal that there are some peaks at lower temperature and some at higher temperature [22, 23].

Peaks at a lower temperature are associated with dissociation, and higher temperature peaks are due to ionization. SF₆, CF₃I, and their mixture exhibit many dissociation peaks due to successive dissociation reactions. As far as ionization peak is concerned, SF₆ and its mixture have peaked around 17 000 K almost 2000 K higher than other gases. This is due to the presence of fluorine that has higher ionization energy. In recent years, mixtures such as SF₆/Cu [20], CO₂/Cu

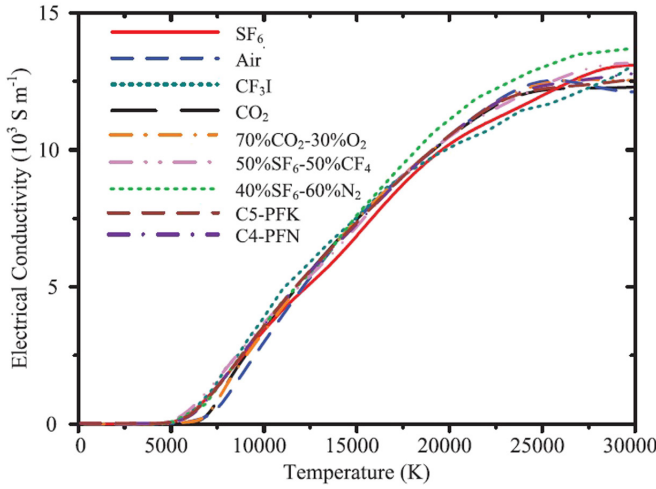


Fig. 1. Electrical conductivity of gases vs. temperature [21].

[24, 25], and air-CO₂-SF₆/polytetrafluoroethylene (PTFE) have been studied for thermophysical properties [26, 27]. Some of the results are shown in Fig. 3 and 4.

It is obvious from the figures that low ionization energy of metal improves electrical conductivity and makes it to start at lower temperature and rises with higher slope. But, there was no significant change in thermal conductivity; however, PTFE addition increases thermal conductivity and also helps to increase pressure in arc-quenching chamber as well, which boosts the thermal cooling capability of the medium. It was also concluded that the addition of PTFE in CO₂ has more effect as compared to addition of SF₆ for thermal conductivity and that the addition of Cu in CO₂ has a significant change in electrical conductivity at lower temperature regions as compared to SF₆.

Ionization potential of gas is another important factor to understand collision behavior during the breakdown process. Table I gives the

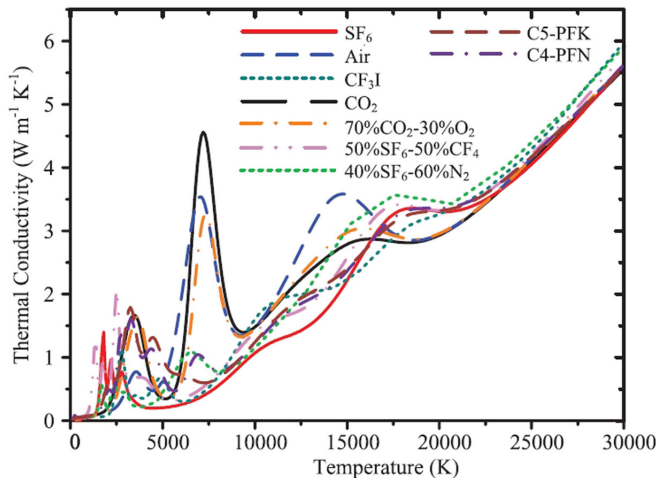


Fig. 2. Thermal conductivity of gases vs. temperature [22].

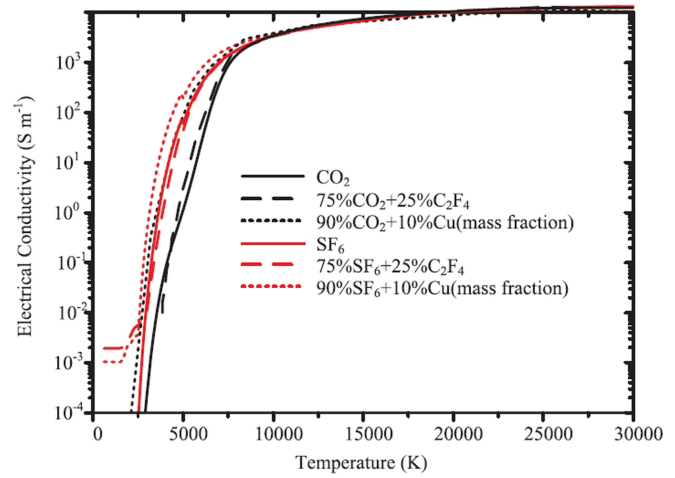


Fig. 3. Thermophysical properties of mixture (electrical conductivity) [26].

comparison of ionization potential of gases, which reveals SF₆ has the highest ionization potential. SF₆ can easily attach to low-energy electrons and hence reduces free electron density owing to good dielectric strength. CF₄, C₃F₈, C₂F₆, and CO₂ also have some reasonable ionization potential.

B. Dielectric Strength

At early stage, when research was started to find the replacement for SF₆, natural gases or mixed gases were experimented, and it was found that the dielectric strength of mixed gases with SF₆ is slightly better than that of pure gases [28-30]. Generally, electronegative gases exhibit good dielectric strength but have high boiling point. In contrast, non-electronegative gases such as CO₂ and N₂ have low boiling point and low dielectric strength, some fraction of SF₆ (i.e. around 0.4–0.45) [15]. To use natural gases, more volume or high pressure is required to meet the dielectric strength which leads to a significant increase in size and cost, which is undesirable

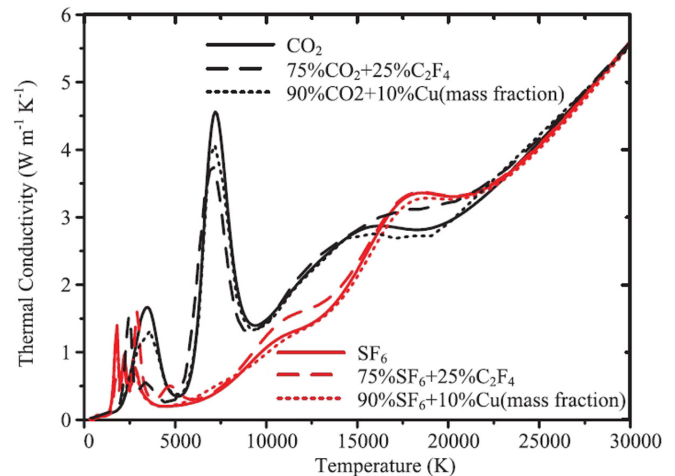


Fig. 4. Thermophysical properties of mixture (thermal conductivity) [26].

for design consideration. Table I summarizes the comparison among pure natural gases and some other substitutes under consideration vs. SF₆. Dry air was also tested in the last 2 decades and successfully used for medium voltages such as 12 kV/24 kV; ring network cabinet uses dry air or N₂ [30, 31], but its dielectric strength is also too low that it requires high pressure. Pure CF₃I has higher dielectric strength as compared to SF₆, almost 1.2 times of SF₆ in comparison with other gases that are depicted in Table I.

CF₃I/N₂ or CF₃I/air mixtures having 60% of CF₃I exhibit almost the same $v-t$ characteristics as that of SF₆ under same pressure [32]. Breakdown test was conducted for the mixture (CF₃I/CO₂) with a ratio of 30%/70% which exhibits dielectric strength almost 0.8 times of that of SF₆ [33, 34].

Recently, studies have been conducted for the mixture of CF₃I/N₂ [35, 36]. In non-uniform AC field configuration with plate–needle, the result showed that the CF₃I/N₂ mixture with a ratio of 30%/70% has dielectric strength 0.9 times of that of SF₆ up to distance of 5 mm at 0.3 MPa, which is even better than pure CF₃I in non-uniform field, exhibiting positive synergistic effect [33]. Lightning impulse test was carried out to investigate the withstand voltage performance under lightening impulse for 252 kV gas-insulated transmission lines [33], and it was found that CF₃I/N₂ mixture with ratio of 20%/80% exhibits withstand performance 0.9 times of that of SF₆/N₂ of same ratio and 77% of pure SF₆ pure.

Gas-insulated switchgear (GIS) 145 kV was tested for withstand voltage with air and C₆F-ketone, and the result was almost the same as the dielectric strength of SF₆. For this, GIS has filling pressure of 6 bar,

while C₆F-ketone has 0.6 bar with temperature of 35°C below which C₆F-ketone will liquefy [17].

Mixture R₁₂ with N₂ in ratio of 80%/20% shows almost 90% higher dielectric strength than that of SF₆ gas at 50 lb/in² under AC voltage, while R₁₃₄ with N₂ in 80%/20% ratio shows 85% higher strength than that of SF₆ [19, 20]. It was also found that further addition of R₁₃₄ and R₁₂ does not bring a rapid increase in breakdown voltage due to low energy electron attachment [19, 20]. Synergistic effect was found positive for more than 70% content of dichlorodifluoromethane with pressure at least 25 lb/in² [19].

Dielectric strength of heptafluoroisobutyronitrile (C₄F₇N) is almost twice of SF₆ at atmospheric pressure [17, 37], as shown in Table I, but its liquefaction temperature being high enforced researcher to use it with mixture. Literature shows that CO₂ was found to be the best one to mix [17, 37-42]. Mixture of (C₄F₇N) with CO₂ is termed as green gas (g³). Depending on minimum operating temperature and maximum filling pressure, g³ and (C₄F₇N) mixing ratio may vary, like 4%, 6%, 10%, or 20% of volume. It was found that GWP of the (C₄F₇N/CO₂) mixture in 4%/96% ratio was only 378, around 1.6% of SF₆ [38]. The power frequency dielectric strength of (C₄F₇N/CO₂) mixture with mixing ratio of 18%/20% volume of (C₄F₇N) content is almost equivalent to SF₆ [37, 40]. Fig. 5 explains dielectric strength variation with varying mixing ratio. Lightning impulse test shows that dielectric characteristics at 0.88 MPa and 1.04 MPa are similar to SF₆ at 0.55 MPa and 0.65 MPa [37, 40], respectively. In a uniform field with plane–plane electrode configuration, dielectric strength for (C₄F₇N/CO₂) with a mixing ratio of 15%/85% was found to be 85.29 kV/mm under 0.1 MPa pressure, which is very near to SF₆, with 86.30 kV/mm for identical pressure [42]. And when contents of (C₄F₇N) were increased to 20%, the mixture exhibited a dielectric strength of 90.25 kV/mm higher than SF₆ [42]. So, (C₄F₇N) with CO₂ is a very promising substitute to replace SF₆ in terms of dielectric strength.

C. Arc Quenching

Dry air and CO₂ have shown auspicious characteristics as far as arc-quenching mechanism is considered. It has been experimented that

TABLE I.
GWP AND DS OF VARIOUS SUBSTITUTES IN COMPARISON WITH SF₆. [9,15,18,42-40,48,62,73,74-77]

Gas Formula	GWP	Dielectric Strength (p.u)	Ionization Potential (eV)	Boiling Point (°C at 0.1 MPa)
SF ₆	~23 000	1	15.32	–63
Air	0	0.43–0.5	–	–194
CO ₂	1	0.45	13.78	–79
N ₂	0	0.4	–	–196
CF ₃ I	~0.5	1.21	10.28	–22.5
C ₆ -PFK	1	>2	–	49
C ₅ -PFK	1	~2	11.03	27
C ₃ F ₈	8800	0.9	13.38	–37
C ₂ F ₆	12 200	0.76	13.6	–78.1
R ₁₂	2400	0.9	–	–29.8
R ₃₄	1300	0.85	–	–27
C ₄ F ₇ N	~2100	2.2	11.88	–4.7

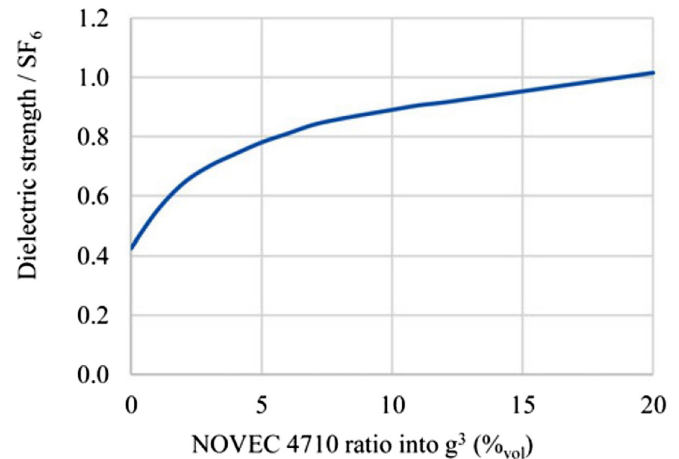


Fig. 5. Comparison of dielectric strength of SF₆ vs. C₄F₇N/CO₂ with different mixing ratio [41].

an increase in pressure from 0.2 MPa to 0.6 MPa increases power loss from 0.32 kW to 0.78 kW for CO₂ as arc-quenching medium, and time constant decreases from 1.3 μs to 0.7 μs with a max value of 1.1 kA [43]. Thermal interruptions of CO₂, SF₆, and some other gases have also been experimented [44-47], to find a comparison of post arc capabilities. Some of the results are depicted in Table II, and characteristic curves have been represented in Fig. 6.

As far as the mixture of gases is concerned, SF₆/N₂ has attracted much attention due to its synergistic effect in dielectric strength and arc interruption. It was also found that a better rate of rise of recovery voltage (RRRV) can be obtained if appropriate ratio of N₂ is mixed with SF₆ [48]. Mixture containing 31% of N₂ and 69% SF₆ exhibited much improved RRRV as compared to SF₆ only [49]. Puffer type gas circuit breaker was experimented with mixture of 0.2 MPa-N₂/0.3 MPa-SF₆ and got 0.76 times more di/dt than that of pure SF₆ [49]. Critical RRRV and di/dt were very much improved by increasing SF₆ contents in the mixture of SF₆/CO₂ [50]. For 126 kV puffer type gas circuit breaker, if SF₆ concentration is increased from 0%, 20%, and 50%, then RRRV before current zero improves from 39%, 45%, and 70%, respectively [51].

The arc extinguishing capability of pure CF₃I is around 90% of that of SF₆, but pure CF₃I has a bit higher boiling point as compared to SF₆ and cannot be used in extremely cold regions [52]. Again, the mixture with natural gases showed improved boiling point as well as arc extinguishing capability [52]. For mixtures of (CF₃I/N₂), (CF₃I/CO₂), and CF₃I/air, transport coefficient and thermodynamic properties were also investigated, and the result showed that around 30% content of CF₃I may be used as a possible substitute [53].

C₅-PFK, C₆-PFK, and mixture were analyzed for arc quenching and insulating properties by ASEA Brown Boveri (ABB) is a Limited Company (Multinational Corporation) and encouraging results were found [54-57]. C₅-PFK with N₂ and O₂ for medium voltage and C₅-PFK with CO₂ and O₂ for HV GIS were recommended. HV GIS with rating

170 kV/31.5 kA and medium-voltage switchgear 22 kV/1600 A for feeders and 22 kV/2000 A for bus bars have been installed and operating satisfactorily in Germany and Switzerland since 2015 [52, 57]. Post arc current measurement was carried out with a self-blast live tanker breaker and found that peak/maximum value of post arc current is very near to SF₆. Table II summarizes the post arc current peak values and duration of different gases.

Typically, Vermeer's constant is used to comprehend heat dissipation capability, and to do so, temperature rise test was conducted on 420 kV bus bar keeping pressure as 5.5 bar and operating temperature as -25°C. The constant for heptafluoroisobutyronitrile was determined to be 13.8, higher than SF₆, while the constant for green gas, mixture of heptafluoroisobutyronitrile and carbon dioxide (C₄F₇N/CO₂), was little lower than that of pure SF₆ but still better than CO₂ [17].

D. Partial Discharge and Flashover

Natural gases when mixed with other gases improve partial discharge characteristics, for example, partial discharge properties were found better for mixture (CF₃I/CO₂) than (SF₆/CO₂), but it demands a higher ratio. To get exceeded level than SF₆, the weightage of CF₃I in CO₂ must be 30%/40% [4, 58]. It was also found that inception voltage (+) is better for (CF₃I/CO₂) than that of (CF₃I/N₂) [59], and so, it was concluded that the synergistic effect in terms of inception voltage is higher for CO₂ as compared to N₂.

Unlike other gases, C₅-PFK decomposition process is irreversible during arc, discharge, or thermal decomposition. Partial discharge test on C₅-PFK was performed [60], and it was found that decomposed products do not recombine to their original structure, and some of the by-products were also toxic.

Partial discharge (PD) test has also been carried out on mixture C₄F₇N/CO₂ in 4%/96% ratio, and it was found that inception voltage is around 0.76–0.84 of SF₆ with longer rising time and pulse width PD pulses [61]. So from PD viewpoint, it requires higher pressure or increased content of C₄F₇N (3M™ Novec™ 4710 dielectric fluid) to meet the requirement of SF₆; however, those studies are not available yet. Recently some research has been carried out to present model for discharge process. Discharge of flowing gases includes three basic phases : a) deflection of the main discharge path, b) blowing away of some electrons, and c) decrease in gas density [63]. This modeling will enable the researcher to calculate breakdown voltage.

Solid material–gas interaction is another important factor to be discussed especially for usage in GIS as linked insulation fails at

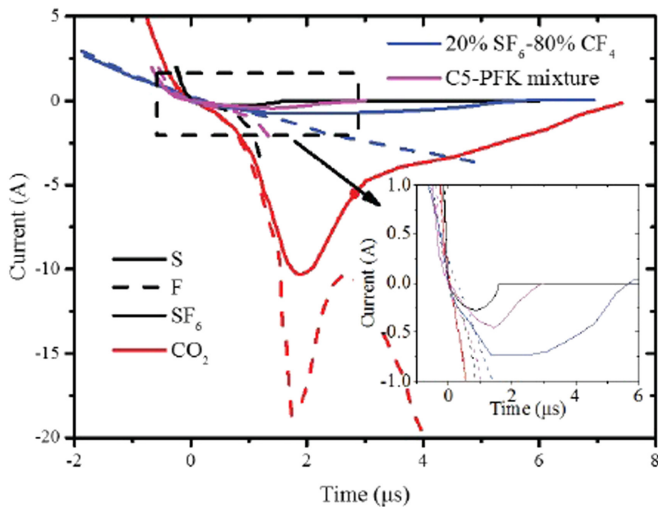


Fig. 6. Comparison of post arc current of CO₂, SF₆, and mixture 20%SF₆-80% CH₄ (S: Success, F: Failure), [46-48].

TABLE II.
POST ARC PEAK CURRENT AND DURATION [46-48]

Gases	Post Arc Current Peak (A)	Duration (μs)
SF ₆	0.272	1.59
C ₅ F-PFK mixture	0.457	2.94
SF ₆ /CH ₄ -20%/80%	0.742	5.81
CO ₂	10.3	7.42

lower voltage due to flashover in solid material. Pure N₂, CO₂, and air exhibit very lower flashover characteristics as compared to SF₆; however, the trend is much similar. And adding SF₆ to natural gases improves their flashover voltages [64], as shown in Fig. 7.

Flashover characteristics were found better for (CF₃I/N₂) for 30%/70% ratio than that of (SF₆/N₂) for 20%/80% [65] under AC and impulse voltage both, though it had slightly lower dielectric strength. Study of surface flashover for (C₄F₇N/CO₂) has been carried out [66], with epoxy insulator, and it was found that (C₄F₇N/CO₂) with ratio 13%/87% exhibits almost 0.8 times of SF₆ flashover voltage and that further increase in the content of (C₄F₇N) can lead to saturation of surface flashover [66].

III. DISCUSSION

There are also some other necessary aspects to be discussed such as boiling point, decomposed by-products, and toxicity. SF₆ has boiling point (−64°C), though it is sufficient for most of the applications but still high as compared to natural gases such as N₂ (−196°C), air (−194°C), and CO₂ (−79°C). [15]. Compressed air, CO₂, and N₂ have been successfully implied up to 145 kV switching devices as insulating medium [67], but to use natural gases, more volume or high pressure is required to meet the required electrical dielectric strength which leads to a significant increase in size and cost, undesirable for design consideration. That is why natural gases are preferred for mixture as buffer gases to reduce overall boiling point.

Boiling point of some gases is depicted in Table I, which shows that fluoroketones have very high boiling point, limiting their usage in icy/snowy zones. C₆-PFK has boiling point of 49°C and C₅-PFK has 27°C, which means it liquefies under standard conditions. However, it can be used with a mixture of N₂ or air. GIS 145 kV was tested for withstand voltage with air and C-PFK, and results were encouraging [17, 18], but the decomposition process is irreversible during arc, discharge, or thermal decomposition for C₅-PFK [68, 69] and also for

(C₆F₁₂O/CO₂) mixture [70], so properties will differ prior and post arc state which limits its usage in GCB.

CF₃I despite its good insulating properties has a higher boiling point of about −22.5°C, which means this gas cannot be used alone and hence mixing with natural gases is recommended. There is another issue associated with CF₃I, that is, its by-products such as C₂F₆, C₃F₈, C₃F₆, CHF₃, and C₂F₅I are toxic [71-73]. Gas itself is categorized as carcinogenic and mutagenic that will be risky to be utilized, due to health hazard issues.

Dichlorodifluoromethane (R₁₂) and tetrafluoroethane (R₁₃₄) also have higher boiling point at atmospheric pressure, such as −29.8°C and −26.3°C, respectively [19, 20]. This was similar with that of CF₃I and hence mixing with natural gases is recommended. However, the mixture will have its own limits because of the lower dielectric strength of natural gases. Issue with R₁₂ is that it contains chlorine that causes ozone depletion [19]. R₁₃₄ has an issue of self-recoverability as AC power frequency breakdown tests show that after tenth shot, breakdown voltage comes down very quickly because of carbon deposit formation on the electrode [20].

(C₄F₇N) has very high boiling point of about −4.7°C [17, 41], and its by-products during decomposition process are C₃F₇, C₃F, CN, CNF, CF, CF₂, CF₃, CFCN, F, free radicals, and CF₄ [74]. Some free radicals recombine to produce C₂F₆, C₃F₈, CF₃CN, CO, and CF₄, some of which are low toxic compounds. However, the addition of CO₂ lowers its boiling point, and less decomposed products are generated [75]. In pure (C₄F₇N) at 2400 K, products were about 96%, while these were reduced to 58% in (C₄F₇N/CO₂) mixture [75]. CF₄ and C were very much reduced and precipitate carbon formation was avoided, so green gas (C₄F₇N/CO₂) is a better option than pure (C₄F₇N). Another mixture of (C₄F₇N/N₂/O₂) has also been tested, and less solid precipitate was produced with much better dielectric performance [76, 77]. However, toxicity assessment of (C₄F₇N) and its by-products recommends taking measures for eye safety and respiration [78].

IV. CONCLUSION

From the discussion, it is obvious to conclude that natural gases are classified as an excellent choice for mixture component to reduce boiling point, attain lower GWP and better arc-quenching capabilities (especially CO₂ in terms of arc quenching). Trifluoroiodomethane despite considerable dielectric strength and decent arc-quenching capabilities with a mixture of natural gases will be risky to be utilized, due to health hazard issues as being carcinogenic and mutagenic gas. Dichlorodifluoromethane (R₁₂) and tetrafluoroethane (R₁₃₄) suffer the problem of ozone depletion and self-recoverability issues, respectively. Perfluoroketones, especially C₅-PFK, has a good potential for replacement, but irreversible decomposition process and high liquefaction temperature are still hindrance in complete replacement. Thus, heptafluoroisobutyronitrile (C₄F₇CN) is the one that has upright potential to replace SF₆ as it has wonderful dielectric strength and moderate global warming potential. Adding CO₂ enables to get much lower GWP level, lower liquefaction point, better arc-quenching ability, and much reduced decomposed products are obtained. So green gas, as labeled to mixture (C₄F₇CN/CO₂), is declared to be the best replacement for SF₆ at the time.

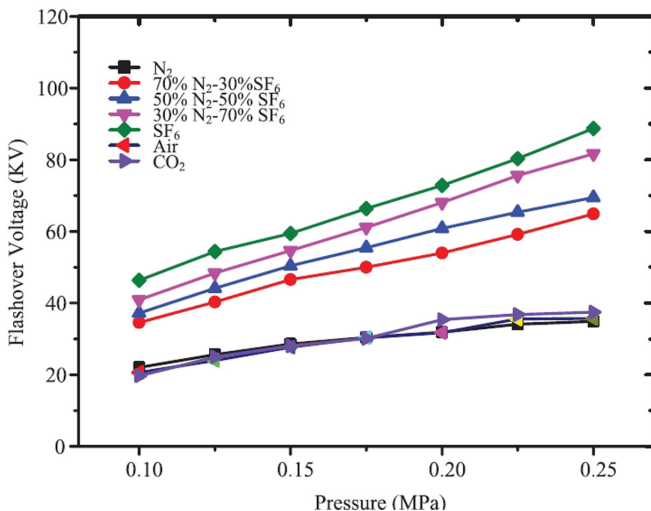


Fig. 7. Flashover comparison of different gases [66].

V. FUTURE WORKS

Though (C₄F₇CN) has shown a remarkable potential to replace SF₆, it is at the initial stages of research, and much deep study is still required to replace it completely. Studies for compatibility with other materials have been started to investigate, but very few studies have been conducted for streamer radii and leader propagation. Basic physical properties, electron transport coefficients, and radiation properties of relatively new gases must also be investigated. Much study is needed to find an optimum compromise among insulation performance, environmental concerns, health issues, safety concerns, and liquefaction temperature.

Peer Review: Externally peer reviewed.

Conflict of Interest: The authors have no conflict of interest to declare.

Financial Disclosure: The authors declared that this study has received no financial support.

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